

Public Products List

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PCI Title : BlueNRG-LPS (BlueNRG-332x) seal ring compatibility with WLCSP Package *PCI Reference :* MDG/23/13817

Subject : Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

	BLUENRG-332AT	BLUENRG-332AC	
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PRODUCT/PROCESS CHANGE INFORMATION PCI 13817– Additional information

BlueNRG-LPS (BlueNRG-332x) seal ring compatibility with WLCSP package

MDG - Microcontrollers Division (MCD)

What is the change?

Square edge Seal Ring used for QFN32 is not compatible with WLCSP package. Beveled edge seal ring is mechanically more reliable for WLCSP and is also reliable for QFN package. Uniformization of the seal ring is mandatory for manufacturing flexibility.





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